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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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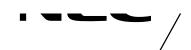
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# MOS FIELD EFFECT TRANSISTOR NP70N10KUF

(TO-263)

# SWITCHING **N-CHANNEL POWER MOS FET**

#### **DESCRIPTION**

The NP70N10KUF is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
NP70N10KUF-E1-AZ Note	Pure Sn (Tin)	Tape	TO-263 (MP-25ZK)
NP70N10KUF-E2-AZ Note		800 p/reel	typ. 1.5 g

Note See "TAPE INFORMATION"

#### **FEATURES**

- Channel temperature 175 degree rating
- Super low on-state resistance

 $R_{DS(on)} = 20 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = 10 \text{ V, ID} = 35 \text{ A)}$ 

• Low Ciss: Ciss = 2500 pF TYP.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vss = 0 V)	VDSS	100	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	I <sub>D(DC)</sub>	±70	Α
Drain Current (pulse) Note1	D(pulse)	±135	Α
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T1</sub>	1.8	W
Total Power Dissipation (Tc = 25°C)	P <sub>T2</sub>	120	W
Channel Temperature	Tch	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to +175	°C
Single Avalanche Current Note2	las	22	Α
Single Avalanche Energy Note2	Eas	48	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V, L = 100  $\mu$ H

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance 1.25 °C/W Rth(ch-C) Channel to Ambient Thermal Resistance °C/W Rth(ch-A) 83.3

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Document No. D18040EJ2V0DS00 (2nd edition) Date Published June 2006 NS CP(K)

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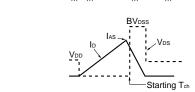
# **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source Breakdown Voltage	BVDSS	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			10	μА
Gate Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±100	nA
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.7	2.5	3.3	V
Forward Transfer Admittance Note	<b>y</b> fs	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A	11	22		S
Drain to Source On-state Resistance Note	RDS(on)	Vgs = 10 V, Ip = 35 A		17	20	mΩ
Input Capacitance	Ciss	Vps = 25 V		2500	3750	pF
Output Capacitance	Coss	Vgs = 0 V		270	410	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		110	200	pF
Turn-on Delay Time	td(on)	VDD = 50 V, ID = 35 A		25	53	ns
Rise Time	tr	Vgs = 10 V		9	23	ns
Turn-off Delay Time	td(off)	$R_G = 0 \Omega$		48	96	ns
Fall Time	tf			7	18	ns
Total Gate Charge	Q <sub>G</sub>	VDD = 80 V		50	75	nC
Gate to Source Charge	Qgs	Vgs = 10 V		16		nC
Gate to Drain Charge	Q <sub>GD</sub>	ID = 70 A		19		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = 70 A, VGS = 0 V		1.0	1.5	V
Reverse Recovery Time	trr	IF = 70 A, VGS = 0 V		88		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		245		nC

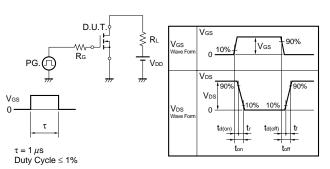
Note Pulsed

# TEST CIRCUIT 1 AVALANCHE CAPABILITY

# $R_{G} = 25 \Omega$ $V_{GS} = 20 \rightarrow 0 \text{ V}$ $R_{G} = 25 \Omega$ $V_{D}$ $V_{D}$ $R_{G} = 25 \Omega$ $V_{D}$ $R_{G} = 25 \Omega$ $R_{G} = 25 \Omega$



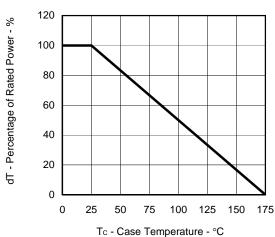
# TEST CIRCUIT 2 SWITCHING TIME



# TEST CIRCUIT 3 GATE CHARGE

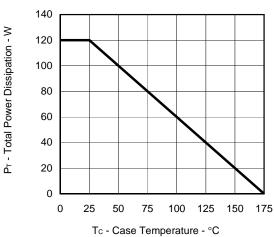
# TYPICAL CHARACTERISTICS (TA = 25°C)

#### DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

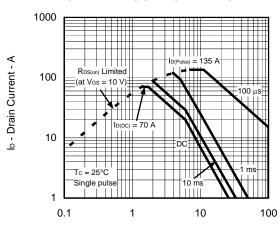


# CASE TEMPERATURE

TOTAL POWER DISSIPATION vs.

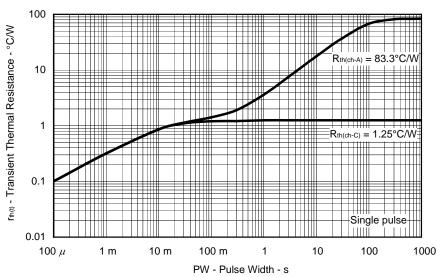


#### FORWARD BIAS SAFE OPERATING AREA

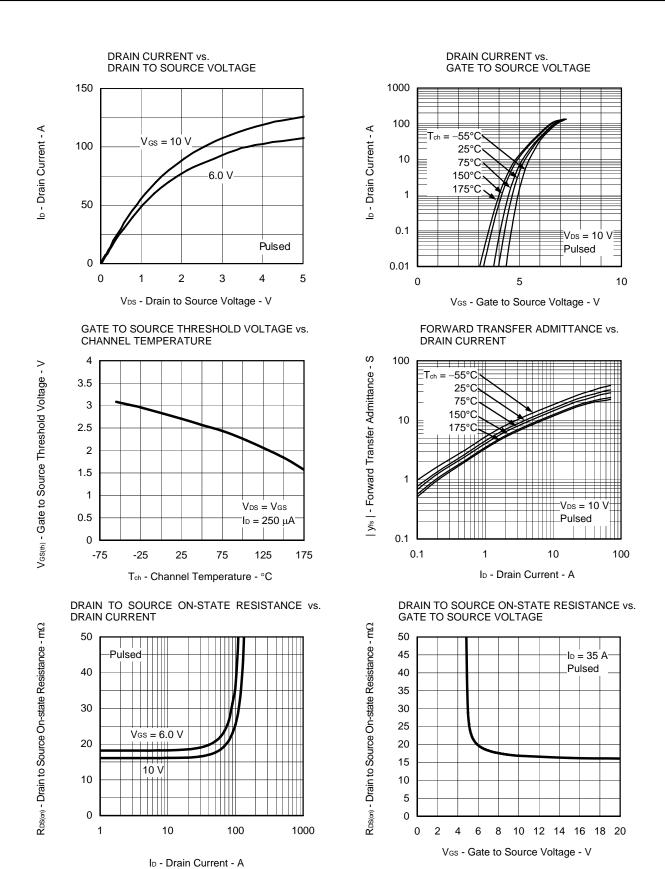


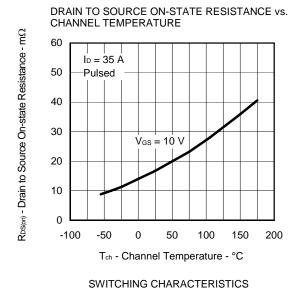
# V<sub>DS</sub> - Drain to Source Voltage - V

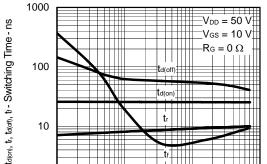
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

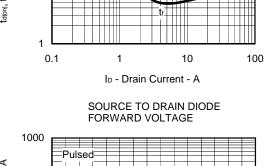


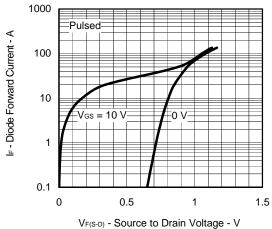
3



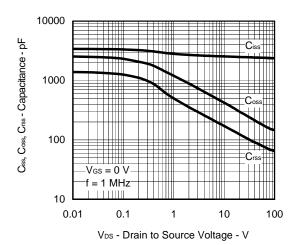




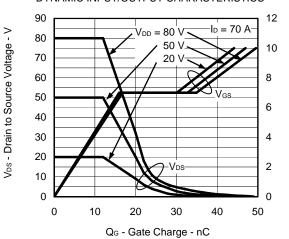




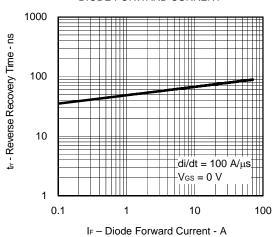




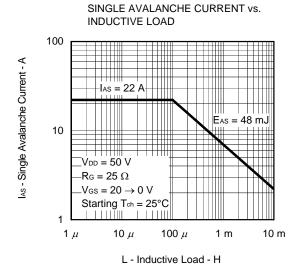
DYNAMIC INPUT/OUTPUT CHARACTERISTICS

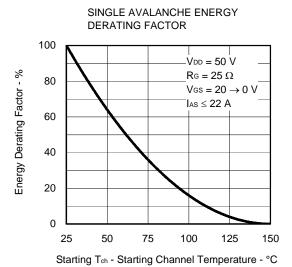


REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



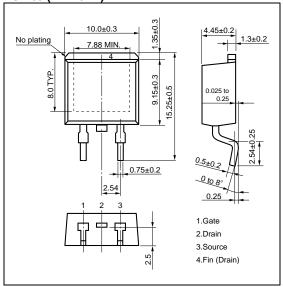
Vos - Gate to Source Voltage - V



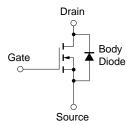


# PACKAGE DRAWING (Unit: mm)

## TO-263 (MP-25ZK)



## **EQUIVALENT CIRCUIT**

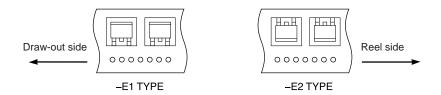


**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

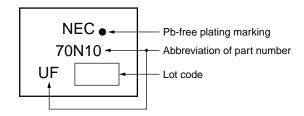
Data Sheet D18040EJ2V0DS 7

## <R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



## MARKING INFORMATION



#### RECOMMENDED SOLDERING CONDITIONS

The NP70N10KUF should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below	IR60-00-3
	Time at maximum temperature: 10 seconds or less	
	Time of temperature higher than 220°C: 60 seconds or less	
	Preheating time at 160 to 180°C: 60 to 120 seconds	
	Maximum number of reflow processes: 3 times	
	Maximum chlorine content of rosin flux (percentage mass): 0.2% or less	
Partial heating	Maximum temperature (Pin temperature): 350°C or below	P350
	Time (per side of the device): 3 seconds or less	
	Maximum chlorine content of rosin flux: 0.2% (wt.) or less	

Caution Do not use different soldering methods together (except for partial heating).

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